V_{RRM} = 650 V Qc $I_F(\leq 150^{\circ}C) = 6$ = 1.39 V

SiC SBD P3D0600612 650V SiC Schottky Diode



Features

- Qualified to AEC-Q101
- Ultra-Fast Switching
- Zero Reverse Recovery Current
- High-Frequency Operation
- Positive Temperature Coefficient on V_F
- High Surge Current
- 100% UIS tested

TO-220I-2

Cathode	1
Anode	2

PIN 10

Standards Benefits

- Improve System Efficiency
- Reduction of Heat Sink Requirement
- Essentially No Switching Losses
- Parallel Devices Without Thermal Runaway



Application

- Consumer SMPS
- Boost Diodes in PFC or DC/DC Stages
- AC/DC Converters



Order Information

Part Number	Package	Marking
P3D06006I2	TO-220I-2	P3D0600612

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1. Maximum Ratings

At T_J= 25°C, unless specified otherwise

Parameter	Symbol	Value	Unit	Test condition
Repetitive Peak Reverse Voltage	V_{RRM}	650	V	T _C = 25℃
Surge Peak Reverse Voltage	V_{RSM}	650	V	T _C = 25°C
DC Blocking Voltage	V_R	650	V	T _C = 25°C
Forward Current	I _F	18 10 6	A	$T_C = 25^{\circ}C$ $T_C = 125^{\circ}C$ $T_C = 150^{\circ}C$
Repetitive Peak Forward Surge Current	I _{FRM}	34 17	A	T_C = 25°C, t_p = 10ms T_C = 125°C, t_p = 10ms
Non-Repetitive Forward Surge Current	I _{FSM}	51 43	А	T_C = 25°C, t_p = 10ms T_C = 125°C, t_p = 10ms
Non-Repetitive Forward Surge Current	I _{F, MAX}	464 432	А	T_C = 25°C, t_p = 10 μ s T_C = 125°C, t_p = 10 μ s
Power Dissipation	P_{tot}	67	W	T _C = 25℃
Operating Junction and Storage Temperature	T _J , T _{STG}	-55 to +175	°C	
TO-220 Mounting Torque M3 Screw	T_{orq}	1 8.8	Nm Ibf-in	

2. Thermal Characteristics

Parameter	Symbol	Values	Unit
Thermal Resistance from Junction to Case	$R_{ heta$ JC	2.24	%C/W

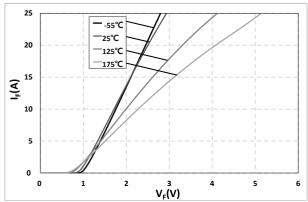
3. Electrical Characteristics

At T_J= 25°C, unless specified otherwise

		Values			3	110	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test condition	
Forward Voltage	V _F	/	1.39	1.6	V	I _F = 6A, T _J = 25°C	
			1.65	/		I _F = 6A, T _J = 175℃	
Reverse Current	I _R		3.8	30	μΑ	V _R = 650V, T _J = 25°C	
			255	/		V _R = 650V, T _J = 175°C	
Total Capacitance	С	/	271		pF	V _R = 0V, T _J = 25°C f= 1MHz	
			31	/		V _R = 200V, T _J = 25°C f= 1MHz	
			25			V _R = 400V, T _J = 25°C f= 1MHz	
Total Capacitive Charge	Q _C	/	15.6	/	nC	V _R = 400V, I _F = 6A T _J = 25℃	
Capacitance Stored Energy	E _C	/	2.01	/	μJ	V _R = 400V	

4. Typical Performance

At T_J= 25°C, unless specified otherwise



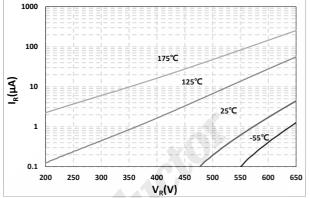
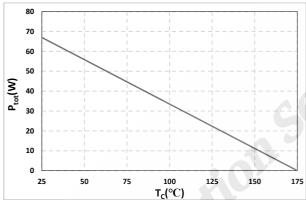


Fig. 1 Typical Forward Characteristics $I_F = f(V_F)$; $T_J = -55^{\circ}C$, $25^{\circ}C$, $125^{\circ}C$, $175^{\circ}C$

Fig. 2 Reverse Characteristics $I_R=f(V_R)$; $T_J=-55$ °C, 25°C, 125°C, 175°C



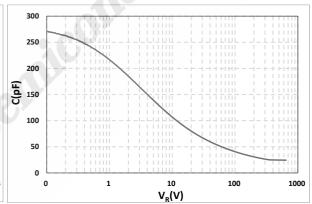
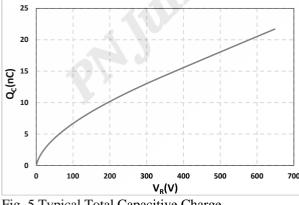


Fig. 3 Typical Power Derating $P_{tot} = f(T_C)$

Fig. 4 Typical Total Capacitance $C=f(V_R)$



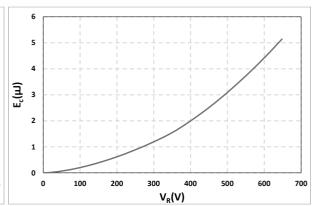
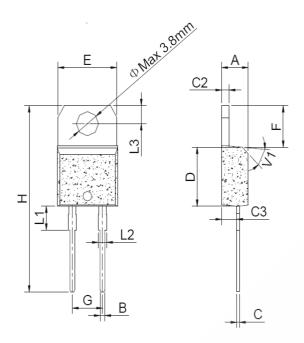


Fig. 5 Typical Total Capacitive Charge $Q_C = f(V_R)$

Fig. 6 Capacitance Stored Energy $E_C = f(V_R)$

5. Package Outlines



	Dimensions							
Ref.	. Millimeters		Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	4.40		4.60	0.173		0.181		
В	0.61		0.88	0.024		0.035		
С	0.46		0.70	0.018		0.028		
C2	1.21		1.32	0.048		0.052		
C3	2.40		2.72	0.094	2	0.107		
D	8.60		9.70	0.339		0.382		
E	9.80		10.4	0.386		0.409		
F	6.55		6.95	0.258		0.274		
G		5.08			0.1			
Н	28.0		29.8	1.102		1.173		
L1		3.75			0.148			
L2	1.14	412	1.70	0.045		0.067		
L3	2.65		2.95	0.104		0.116		
V1		45°			45°			

Drawing and dimensions